

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHIEN-HWA HWANG	08/05/2016
YI-JU LIAO	08/05/2016
TSANG-WEI YU	08/05/2016
LUNG-SHENG TSAI	08/05/2016
PEI-KAI LIAO	08/05/2016
RECEIVING PARTY DATA	
Name:	MEDIATEK INC.
Street Address:	NO. 1 DUSING RD. 1ST.
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15235745
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ATTORNEY DOCKET NUMBER:	MDT-284-2S
NAME OF SUBMITTER:	ZHENG JIN
SIGNATURE:	/zheng jin/
DATE SIGNED:	08/12/2016
Total Attachments: 2	

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ASSIGNMENT OF PATENT APPLICATION

WHEREAS, we, Chien-Hwa Hwang, Yi-Ju Liao, Tsang-Wei Yu, Lung-Sheng Tsai, and Pei-Kai Liao (hereinafter referred to as ASSIGNORS), having post office addresses of: No.255, Guangming 9th Rd., Zhubei City, Hsinchu County 302, Taiwan; 1F., No.40, Ln. 73, Wuling Rd., North Dist., Hsinchu City 300, Taiwan; 1F., No.45, Sec. 2, Jiafeng 6th Rd., Zhubei City, Hsinchu County 302, Taiwan; No.176, Sec. 2, Zhongyi Rd., West Central Dist., Tainan City 700, Taiwan; No. 2, 9th Neighborhood, Wushuang Lane, Mingjian Xia, Nantou County 551, Taiwan; respectively, are the joint inventors of the invention described and claimed in the specification forming part of the United States patent application entitled "SIGNAL MODULATION AND DEMODULATION FOR MULTIUSER SUPERPOSITION TRANSMISSION SCHEME," executed herewith;

WHEREAS, MEDIATEK INC. (hereafter referred to as ASSIGNEE), a corporation organized under the laws of Taiwan and having a place of business at No. 1, Dusing Rd. 1st, Hsinchu Science Park, Hsin-Chu 300, Taiwan, is desirous of acquiring the entire right, title, and interest in and to the invention and in and to any letters patents that may be granted thereof in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign, and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said invention, said application and any and all letters patents which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty, or otherwise, said invention, application and all letters patents on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors an assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer, and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patents on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patents on said invention, for litigation regarding said letters patents, or for the purpose of protecting title to said invention or letters patents therefor.

IN WITNESS WHEREOF, We have hereunto signed our names on the day and year set forth below.

Chien-Hwa Hwang
Inventor's Signature

Chien-Hwa Hwang
Inventor's Printed Name

2016/8/15
Date

Yi-Ju Liao
Inventor's Signature

Yi-Ju Liao
Inventor's Printed Name

2016/8/15
Date

Tsang-Wei Yu
Inventor's Signature

Tsang-Wei Yu
Inventor's Printed Name

2016/8/15
Date

Docket Number: MDT-284-2S

Lung-Sheng Tsai
Inventor's Signature

Lung-Sheng Tsai
Inventor's Printed Name

8/5, 2016
Date

Pei-Kai Liao
Inventor's Signature

Pei-Kai Liao
Inventor's Printed Name

8/5, 2016
Date